

Title (en)

NCFET TRANSISTOR COMPRISING A SEMICONDUCTOR-ON-INSULATOR SUBSTRATE

Title (de)

NCFET-TRANSISTOR MIT EINEM HALBLEITER-AUF-ISOLATOR-SUBSTRAT

Title (fr)

TRANSISTOR NC-FET COMPORTANT UN SUBSTRAT DU TYPE SEMI-CONDUCTEUR SUR ISOLANT

Publication

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Application

**EP 22714482 A 20220317**

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- FR 2022050479 W 20220317

Abstract (en)

[origin: WO2022195226A1] The invention relates to an NCFET transistor comprising a semiconductor-on-insulator substrate for a field-effect transistor, successively comprising, from its base to its surface: a semiconductor carrier substrate (1); a single ferroelectric layer (2), arranged in direct contact with the carrier substrate (1), which layer is designed to be biased so as to form a negative capacitance; and an active layer (3) of a semiconductor material, which layer is designed to form the channel of the transistor, and is arranged in direct contact with the ferroelectric layer (2), said NCFET transistor further comprising a channel (3b) which is arranged in the active layer (3a), a source (11) and a drain (12) which are arranged in the active layer (3a) on either side of the channel (3b), and a gate (10) which is arranged on the channel (3b) and is insulated from said channel (3b) by a gate dielectric (30).

IPC 8 full level

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